

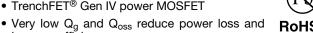
# N-Channel 40 V (D-S) MOSFET



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	40			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0022			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.0032			
Q <sub>g</sub> typ. (nC)	21.5			
I <sub>D</sub> (A) <sup>a</sup>	128			
Configuration	Single			

#### **FEATURES**





 Optimized Q<sub>g</sub>, Q<sub>gd</sub>, and Q<sub>gd</sub>/Q<sub>gs</sub> ratio reduces switching related power loss



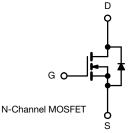
100 % R<sub>a</sub> and UIS tested

improve efficiency

· Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- · Synchronous rectification
- · Synchronous buck converter
- High power density DC/DC
- · Load switching



ORDERING INFORMATION	
Package	PowerPAK 1212-8S
Lead (Pb)-free and halogen-free	SiSS4402DN-T1-GE3
Lead (Pb)-free and halogen-free, BLR and IOL	SiSS4402DN-T1-UE3

<b>ABSOLUTE MAXIMUM RATING</b>	<b>iS</b> (T <sub>A</sub> = 25 °C, ι	ınless otherv	vise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	40	V	
Gate-source voltage		V <sub>GS</sub>	+20 / -16	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		128		
	T <sub>C</sub> = 70 °C	Ι.	103		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	35.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	28 <sup>b, c</sup>	Α	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	300	A	
Continuous accuracy during disade accuracy.	T <sub>C</sub> = 25 °C		59.8		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	4.5 <sup>b, c</sup>		
Single pulse avalanche current  L = 0.1 mH		I <sub>AS</sub>	25		
Single pulse avalanche energy		E <sub>AS</sub>	31.25	mJ	
	T <sub>C</sub> = 25 °C		65.7		
Maximum navver dissination	T <sub>C</sub> = 70 °C		42	W	
Maximum power dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	5 b, c	VV	
	T <sub>A</sub> = 70 °C	1	3.2 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub> -55 to +150		°C	
Soldering recommendations (peak temperature) <sup>c</sup>			260	-0	

THERMAL RESISTANCE RATING	as .				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	R <sub>thJA</sub>	20	25	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	1.5	1.9	C/W

- a. Based on T<sub>C</sub> = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- See solder profile (<a href="https://www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK 1212-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

  Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- Maximum under steady state conditions is 63 °C/W



# Vishay Siliconix

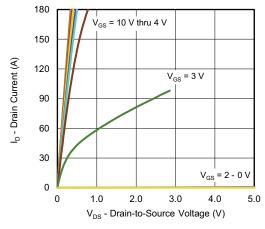
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			•			
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I 050 ·· A	-	25	-	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-5.2	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	-	2.5	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = +20, -16 \text{ V}$	-	-	± 100	nA
Zana anta calta na disaisa accumant		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V	-	-	1	μA
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10	
During a series of the series of	5	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A	-	0.0018	0.0022	
Drain-source on-state resistance a	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A	-	0.0024	0.0032	Ω
Forward transconductance a	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_{D} = 15 \text{ A}$	-	98	-	S
Dynamic <sup>b</sup>			1			I.
Input capacitance	C <sub>iss</sub>		-	3850	-	pF
Output capacitance	C <sub>oss</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	655	-	
Reverse transfer capacitance	C <sub>rss</sub>		-	75	-	
<del></del>		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	46.7	70	
otal gate charge	Q <sub>g</sub>		-	21.5	32	nC
Gate-source charge	$Q_{gs}$	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	9.3	-	
Gate-drain charge	Q <sub>gd</sub>		-	4	-	
Output charge	Q <sub>oss</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V	-	24.5	-	
Gate resistance	$R_g$	f = 1 MHz	0.5	1.1	1.8	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	15	30	
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_1 = 1 \Omega$	-	6	12	1
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	30	60	
Fall time	t <sub>f</sub>		-	6	12	
Turn-on delay time	t <sub>d(on)</sub>		-	26	52	ns
Rise time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_{I} = 1 \Omega$	-	63	126	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	33	66	1
Fall time	t <sub>f</sub>		-	10	20	
<b>Drain-Source Body Diode Characteristic</b>	s		1			I.
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	59.8	_
Pulse diode forward current ( $t_p = 100 \mu s$ )	I <sub>SM</sub>		-	-	300	А
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 5 A	-	0.73	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>		-	29	58	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>E</sub> = 10 A, di/dt = 100 A/us.	-	23	46	nC
Reverse recovery fall time	7 05 00		15	-		
Reverse recovery rise time	t <sub>b</sub>		-	14	_	ns

#### Notes

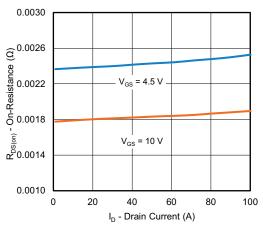
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

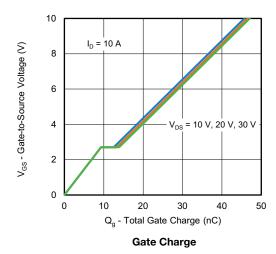


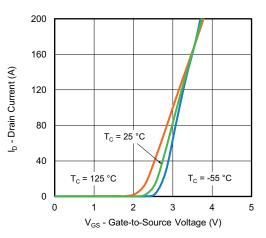


### **Output Characteristics**

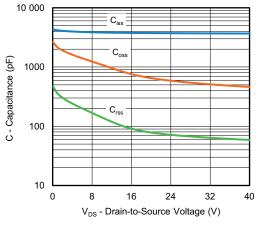


On-Resistance vs. Drain Current

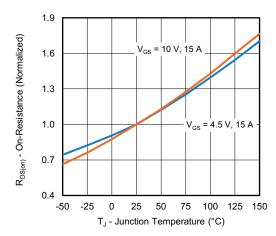




**Transfer Characteristics** 

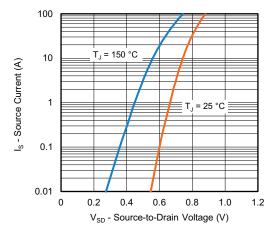


Capacitance

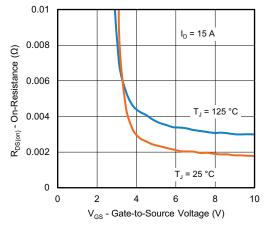


On-Resistance vs. Junction Temperature

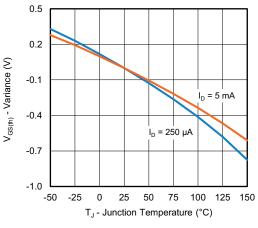




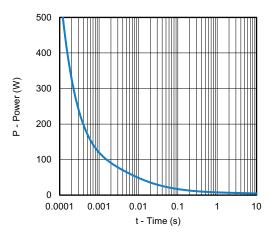
### Source-Drain Diode Forward Voltage



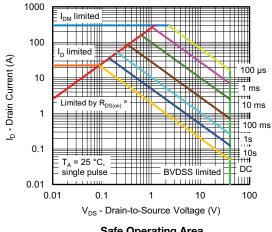
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient

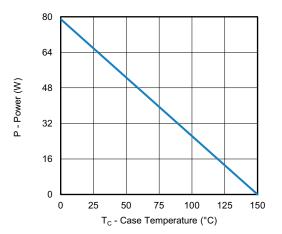


#### Safe Operating Area

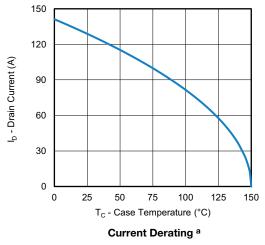
#### Note

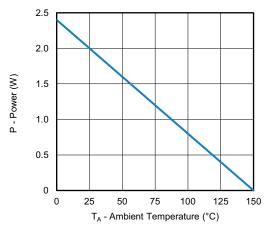
a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified





Power, Junction-to-Case



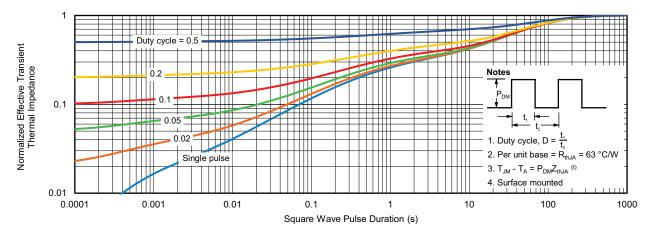


Power, Junction-to-Ambient

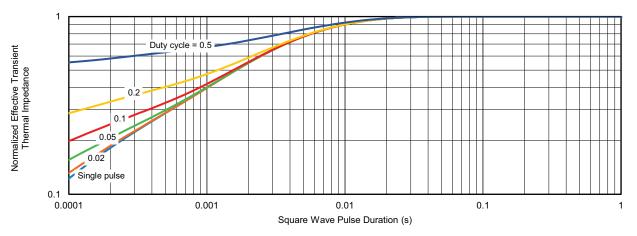
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?62186">www.vishay.com/ppg?62186</a>.



www.vishay.com

# Case Outline for PowerPAK® 1212-8S





DIM.	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.67	0.75	0.83	0.026	0.030	0.033	
A1	0.00	-	0.05	0.000	-	0.002	
A3		0.20 ref.			0.008 ref		
b	0.25	0.30	0.35	0.010	0.012	0.014	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.15	2.25	2.35	0.085	0.089	0.093	
E	3.20	3.30	3.40	0.126	0.130	0.134	
E1	1.60	1.70	1.80	0.063	0.067	0.071	
е		0.65 bsc.			0.026 bsc.		
K		0.76 ref.			0.030 ref.		
K1	0.41 ref.		0.016 ref.				
L	0.33	0.43	0.53	0.013	0.017	0.021	
Z	0.525 ref.				0.021 ref.		

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DWG: 6008



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